Product Summary

V_{RRM} (V)	I_F (A)	V_F Max (V) @ I_F = 7.5A	I_R Max (µA)
800	15	0.90	10

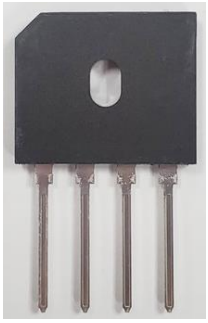
Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop
- Ideal for Printed Circuit Board
- High Surge Current Capability
- UL Recognized File # E95060
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/**

Mechanical Data

- Package: GBU
- Package Material: Plastic Material, UL Flammability Classification 94V-0
- Terminals: Finish – Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Polarity Indicator: As Marked on the Body
- Weight: 4.0 grams (Approximate)

GBU

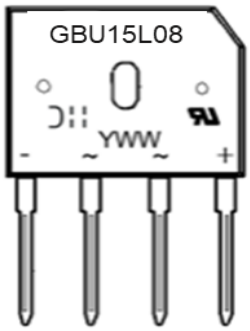


Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
GBU15L08	GBU	20	Tube

Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



GBU15L08 = Product Type Marking Code
= Manufacturer's Code Marking
YWW = Date Code Marking
Y = Last Digit of Year (ex: 3 = 2023)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Maximum Repetitive Peak Reverse Voltage			V_{RRM}	800	V
Average Rectified Output Current	With Heatsink Without Heatsink	T_J = +150°C T_J = +150°C	$I_{F(AV)}$	15 4	A
Peak Forward Surge Current 8.3ms Single Half Sine Wave		T_J = +25°C T_J = +125°C	I_{FSM}	250 170	A
Peak Forward Surge Current 1.0ms Single Half Sine Wave		T_J = +25°C T_J = +125°C	I_{FSM}	550 450	A
I^2t Rating for Fusing (t = 8.3ms)			I^2t	259.4	A^2s
Storage Temperature Range			T_{STG}	-55 to +150	°C
Operating Junction Temperature Range			T_J	-40 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Test Condition	Symbol	Min	Typ	Max	Unit
Breakdown Voltage	I_R = 10μA , T_J = +25°C	V_B	800	—	—	V
Forward Voltage	I_F = 7.5A, T_J = +25°C	V_F	—	0.86	0.9	V
Leakage Current	V_R = 800V, T_J = +25°C	I_R	—	—	10	μA
Typical Junction Capacitance (Note 5)		C_T		160		pF

Thermal Characteristics

Characteristic	Symbol	Typ	Unit
Typical Thermal Resistance (Without Heatsink)	$R_{\theta JC}$ $R_{\theta JL}$ $R_{\theta JA}$	6 9 28	°C/W
Typical Thermal Resistance (Notes 6 & 7)	$R_{\theta JC}$ $R_{\theta JL}$ $R_{\theta JA}$	1 3 6	°C/W

Notes: 5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
6. Thermal resistance junction to case, lead and ambient in accordance with JESD-51.
7. Device mounted on 200mm x 200mm x 5mm CU plate heatsink.

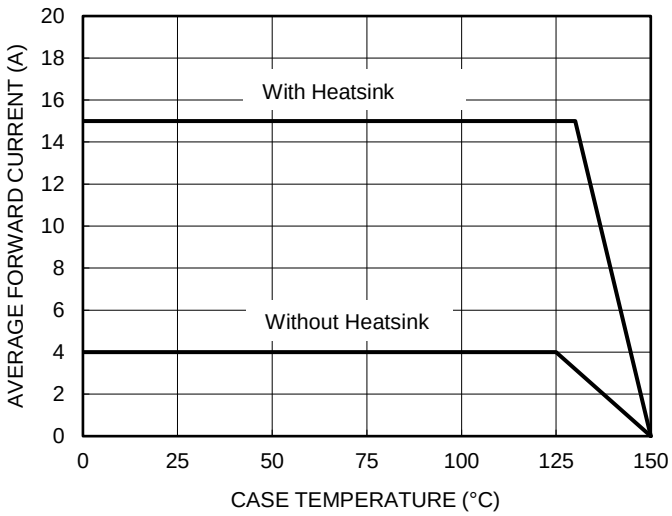


Figure 1. Forward Current Derating Curve

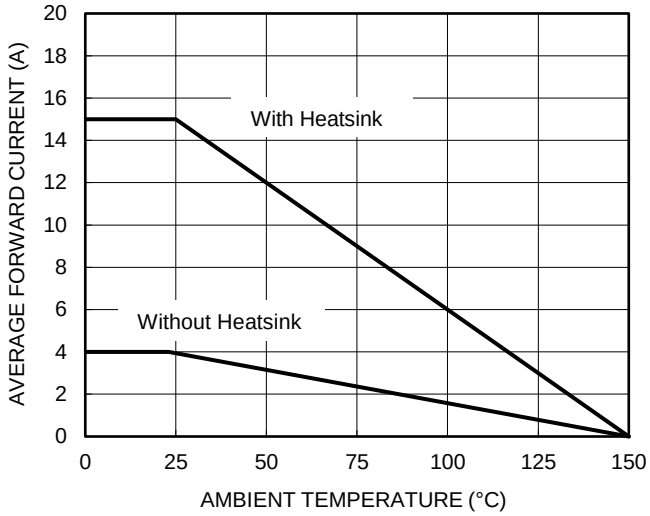


Figure 2. Forward Current Derating Curve

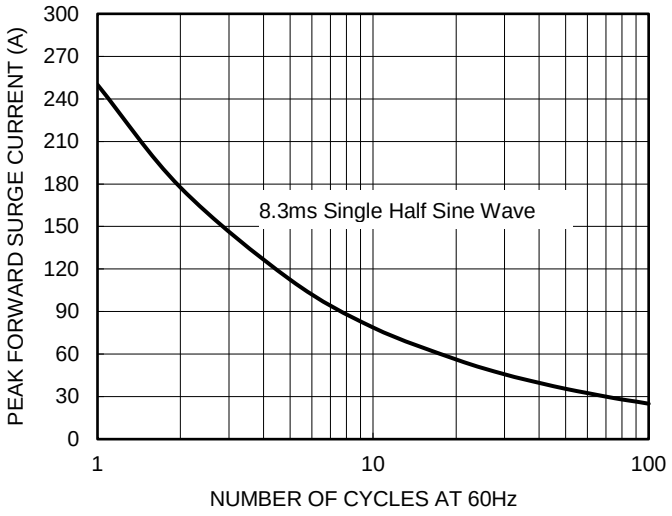


Figure 3. Maximum Non-Repetitive Surge Current

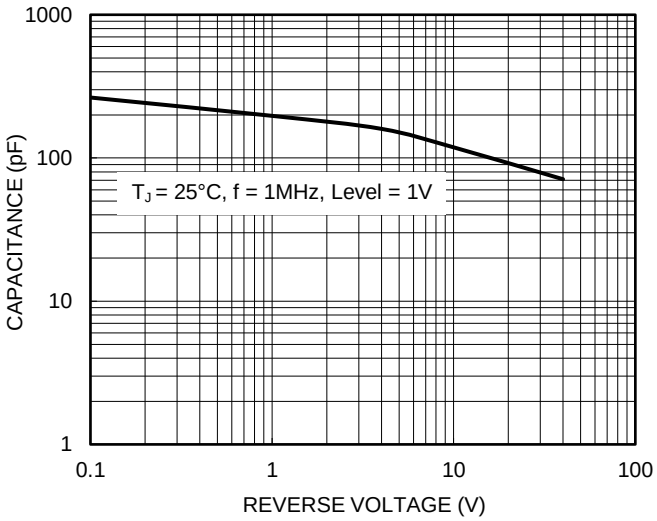


Figure 4. Typical Junction Capacitance

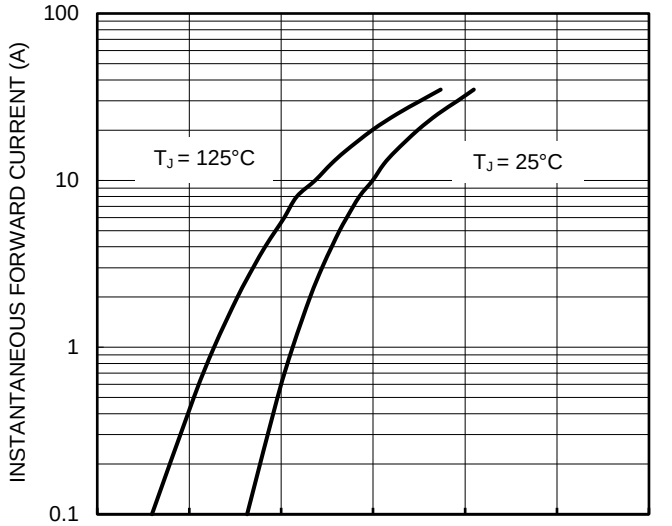


Figure 5. Typical Forward Characteristics

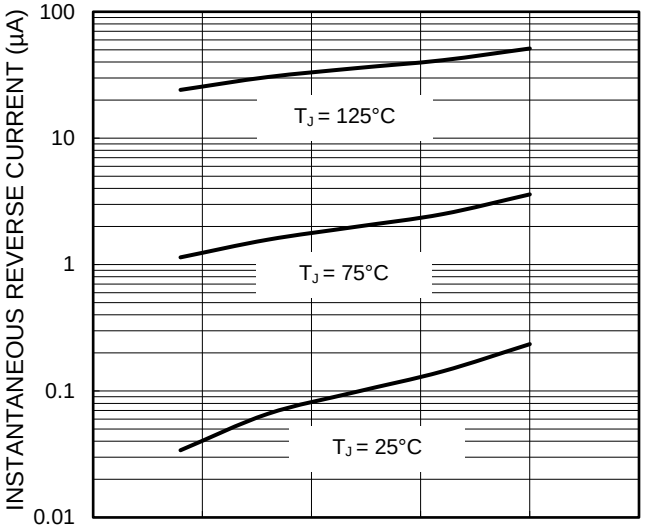
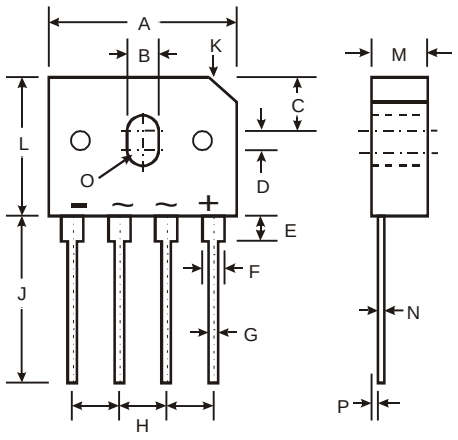


Figure 6. Typical Reverse Characteristics

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

GBU



GBU		
Dim	**Min**	**Max**
A	21.8	22.3
B	3.5	4.1
C	7.4	7.9
D	1.65	2.16
E	2.25	2.75
F	1.95	2.35
G	1.02	1.27
H	4.83	5.33
J	17.5	18.0
K	3.2 X 45°	
L	18.3	18.8
M	3.30	3.56
N	0.46	0.56
O	1.90R	
P	0.76	1.0
All Dimensions in mm		

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